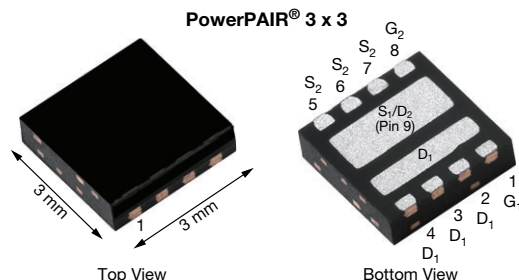


Dual N-Channel 25 V (D-S) MOSFETs



FEATURES

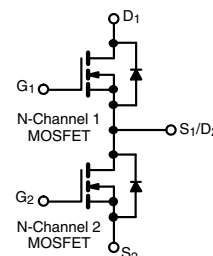
- TrenchFET® Gen IV power MOSFETs
- 100 % R_g and UIS tested
- Optimized Q_{gs}/Q_{gs} ratio improves switching characteristics
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- CPU core power
- Computer / server peripherals
- POL
- Synchronous buck converter
- Telecom DC/DC



PRODUCT SUMMARY		
	CHANNEL-1	CHANNEL-2
V _{DS} (V)	25	25
R _{DS(on)} max. (Ω) at V _{GS} = 10 V	0.0150	0.0100
R _{DS(on)} max. (Ω) at V _{GS} = 4.5 V	0.0250	0.0150
Q _g typ. (nC)	2.1	3.5
I _D (A) ^g	25.3	30 ^a
Configuration	Dual	

ORDERING INFORMATION	
Package	PowerPAIR 3 x 3
Lead (Pb)-free and halogen-free	SiZ328DT-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	CHANNEL-1	CHANNEL-2	UNIT
Drain-source voltage		V _{DS}	25	25	V
Gate-source voltage		V _{GS}	+16, -12	+16, -12	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C	I _D	25.3	30 ^a	A
	T _C = 70 °C		20.2	25.5	
	T _A = 25 °C		11.1 ^{b, c}	15 ^{b, c}	
	T _A = 70 °C		8.9 ^{b, c}	12 ^{b, c}	
Pulsed drain current (100 μs pulse width)		I _{DM}	40	50	
Continuous source drain diode current	T _C = 25 °C	I _S	12.6	13.5	
	T _A = 25 °C		2.4 ^{b, c}	3 ^{b, c}	
Single pulse avalanche current	L = 100 mH	I _{AS}	7	11	mJ
Single pulse avalanche energy		E _{AS}	2.5	6.1	
Maximum power dissipation	T _C = 25 °C	P _D	15	16.2	W
	T _C = 70 °C		9.6	10.4	
	T _A = 25 °C		2.9 ^{b, c}	3.6 ^{b, c}	
	T _A = 70 °C		1.8 ^{b, c}	2.3 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		°C
Soldering recommendations (peak temperature) ^d			260		

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	CHANNEL-1		CHANNEL-2		UNIT
			TYP.	MAX.	TYP.	MAX.	
Maximum junction-to-ambient ^{b, f}	t ≤ 10 s	R _{thJA}	35	43	28	35	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	6.7	8.3	6.3	7.7	

Notes

- Package limited
- Surface mounted on 1" x 1" FR4 board
- t = 10 s
- See solder profile (www.vishay.com/doc?73257). The PowerPAIR 3 x 3 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 80 °C/W for channel-1 and 69 °C/W for channel-2
- T_C = 25 °C



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	Ch-1	25	-	-	V
		V _{GS} = 0 V, I _D = 250 μA	Ch-2	25	-	-	
V _{DS} Temperature coefficient	ΔV _{DS} /T _J	I _D = 250 μA	Ch-1	-	19	-	mV/°C
		I _D = 250 μA	Ch-2	-	18	-	
V _{GS(th)} Temperature coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μA	Ch-1	-	-4.1	-	
		I _D = 250 μA	Ch-2	-	-4.3	-	
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	Ch-1	1.1	-	2.5	V
		V _{DS} = V _{GS} , I _D = 250 μA	Ch-2	1.1	-	2.5	
Gate source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = +16 V, -12 V	Ch-1	-	-	± 100	nA
		V _{DS} = 0 V, V _{GS} = +16 V, -12 V	Ch-2	-	-	± 100	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 25 V, V _{GS} = 0 V	Ch-1	-	-	1	μA
		V _{DS} = 25 V, V _{GS} = 0 V	Ch-2	-	-	1	
		V _{DS} = 25 V, V _{GS} = 0 V, T _J = 55 °C	Ch-1	-	-	5	
		V _{DS} = 25 V, V _{GS} = 0 V, T _J = 55 °C	Ch-2	-	-	5	
On-state drain current ^b	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	Ch-1	10	-	-	A
		V _{DS} ≥ 5 V, V _{GS} = 10 V	Ch-2	10	-	-	
Drain-source on-state resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 5 A	Ch-1	-	0.0120	0.0150	Ω
		V _{GS} = 10 V, I _D = 5 A	Ch-2	-	0.0080	0.0100	
		V _{GS} = 4.5 V, I _D = 5 A	Ch-1	-	0.0175	0.0250	
		V _{GS} = 4.5 V, I _D = 5 A	Ch-2	-	0.0120	0.0150	
Forward transconductance ^b	g _{fs}	V _{DS} = 10 V, I _D = 10 A	Ch-1	-	25	-	S
		V _{DS} = 10 V, I _D = 10 A	Ch-2	-	42	-	
Dynamic ^a							
Input capacitance	C _{iss}	Channel-1 V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz Channel-2 V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	Ch-1	-	325	-	pF
Output capacitance	C _{oss}		Ch-2	-	600	-	
			Ch-1	-	115	-	
			Ch-2	-	230	-	
Reverse transfer capacitance	C _{rss}		Ch-1	-	20	-	
C _{rss} /C _{iss} ratio			Ch-2	-	31	-	
			Ch-1	-	0.060	0.120	
			Ch-2	-	0.052	0.110	
		Total gate charge	Q _g	V _{DS} = 10 V, V _{GS} = 10 V, I _D = 5 A	Ch-1	-	4.6
V _{DS} = 10 V, V _{GS} = 10 V, I _D = 5 A	Ch-2			-	7.5	11.3	
V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 5 A	Ch-1			-	2.1	3.2	
V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 5 A	Ch-2			-	3.5	5.3	
Gate-source charge	Q _{gs}	Channel-1 V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 5 A	Ch-1	-	0.95	-	
			Ch-2	-	1.63	-	
Gate-drain charge	Q _{gd}	Channel-2 V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 5 A	Ch-1	-	0.37	-	
			Ch-2	-	0.54	-	
Output charge	Q _{oss}	V _{DS} = 10 V, V _{GS} = 0 V	Ch-1	-	1.7	-	
			Ch-2	-	3.4	-	
Gate resistance	R _g	f = 1 MHz	Ch-1	0.28	1.4	2.8	Ω
			Ch-2	0.18	0.9	1.8	

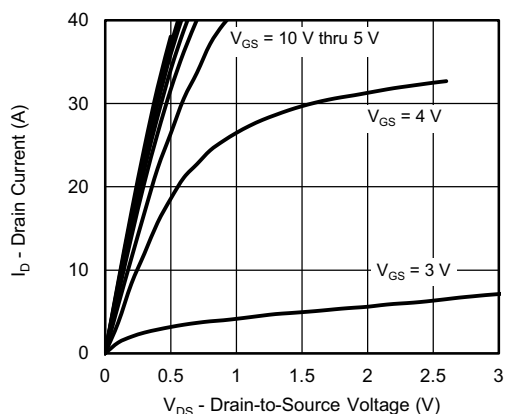
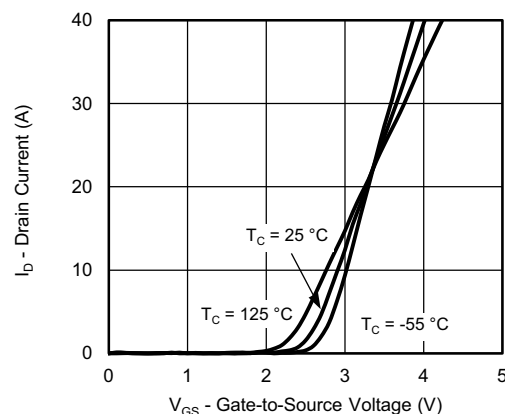
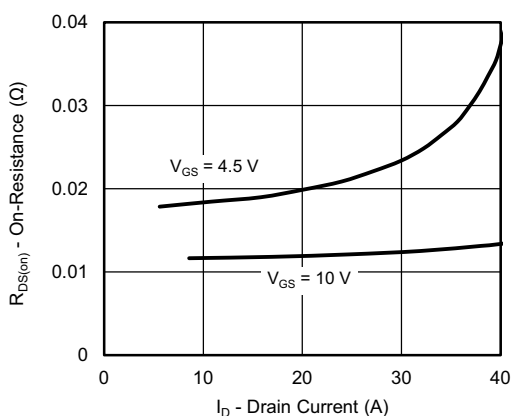
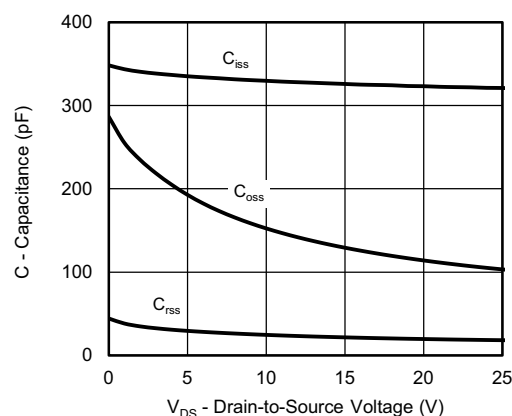
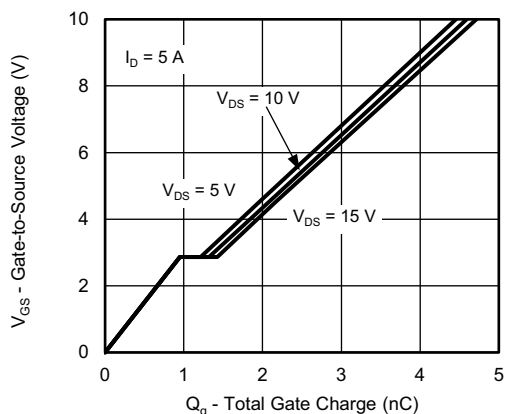
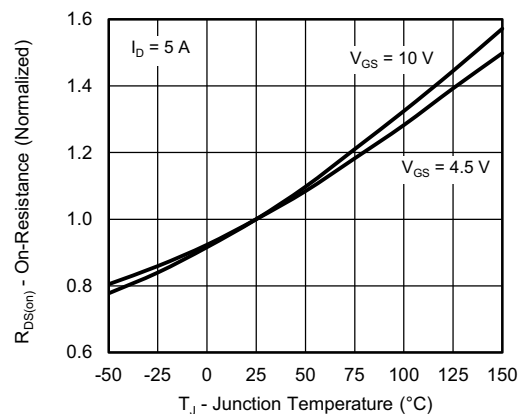


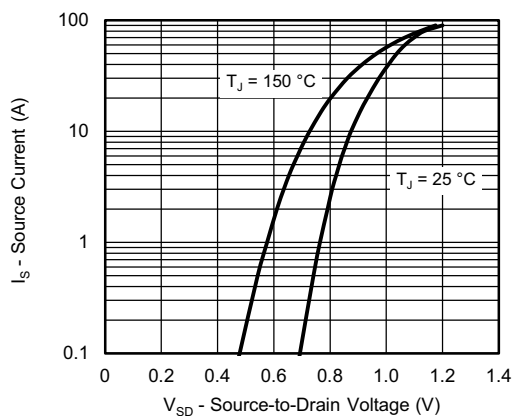
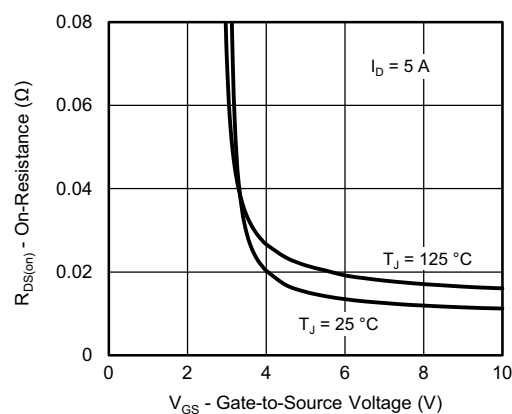
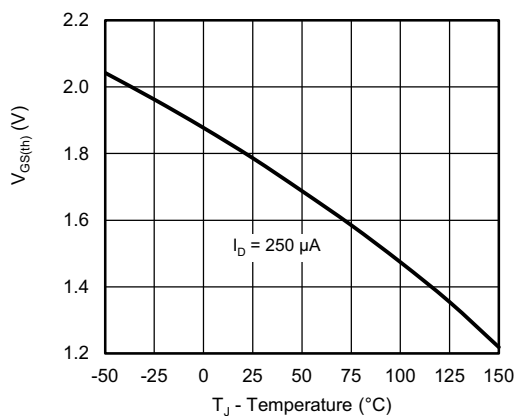
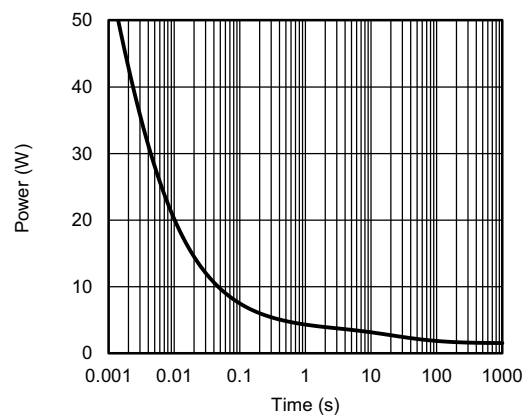
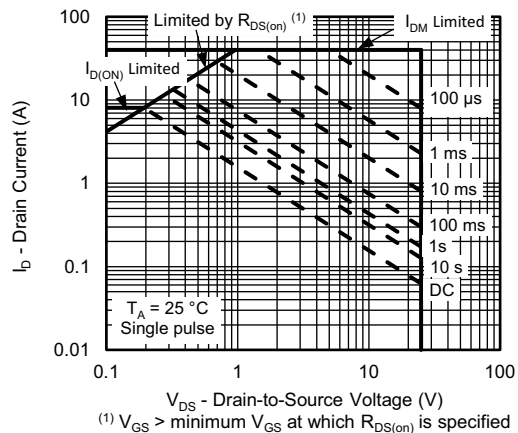
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Dynamic ^a								
Turn-on delay time	t _{d(on)}	Channel-1 V _{DD} = 10 V, R _L = 2 Ω I _D ≅ 5 A, V _{GEN} = 10 V, R _g = 1 Ω	Ch-1	-	7	15	ns	
			Ch-2	-	8	16		
Rise time	t _r		Ch-1	-	11	25		
			Ch-2	-	5	10		
Turn-off delay time	t _{d(off)}	Channel-2 V _{DD} = 10 V, R _L = 2 Ω I _D ≅ 5 A, V _{GEN} = 10 V, R _g = 1 Ω	Ch-1	-	12	25		
			Ch-2	-	15	30		
Fall time	t _f		Ch-1	-	5	10		
			Ch-2	-	5	10		
Turn-on delay time	t _{d(on)}	Channel-1 V _{DD} = 10 V, R _L = 2 Ω I _D ≅ 5 A, V _{GEN} = 4.5 V, R _g = 1 Ω	Ch-1	-	13	30		
			Ch-2	-	15	30		
Rise time	t _r		Ch-1	-	66	75		
			Ch-2	-	61	120		
Turn-off delay time	t _{d(off)}		Channel-2 V _{DD} = 10 V, R _L = 2 Ω I _D ≅ 5 A, V _{GEN} = 4.5 V, R _g = 1 Ω	Ch-1	-	8		20
				Ch-2	-	10		20
Fall time	t _f			Ch-1	-	5		10
				Ch-2	-	5		10
Drain-Source Body Diode Characteristics								
Continuous source-drain diode current	I _S	T _C = 25 °C	Ch-1	-	-	12.6	A	
			Ch-2	-	-	13.5		
Pulse diode forward current (t = 100 μs)	I _{SM}		Ch-1	-	-	40		
			Ch-2	-	-	50		
Body diode voltage	V _{SD}	I _S = 5 A, V _{GS} = 0 V	Ch-1	-	0.82	1.2	V	
		I _S = 5 A, V _{GS} = 0 V	Ch-2	-	0.83	1.2		
Body diode reverse recovery time	t _{rr}	Channel-1 I _F = 5 A, di/dt = 100 A/μs, T _J = 25 °C	Ch-1	-	16	35	ns	
			Ch-2	-	21	40		
Body diode reverse recovery charge	Q _{rr}		Channel-2 I _F = 5 A, di/dt = 100 A/μs, T _J = 25 °C	Ch-1	-	10	20	nC
				Ch-2	-	11	20	
Reverse recovery fall time	t _a	Channel-2 I _F = 5 A, di/dt = 100 A/μs, T _J = 25 °C		Ch-1	-	10	-	ns
				Ch-2	-	11	-	
Reverse recovery rise time	t _b	Ch-1	-	6	-			
			Ch-2	-	10	-		

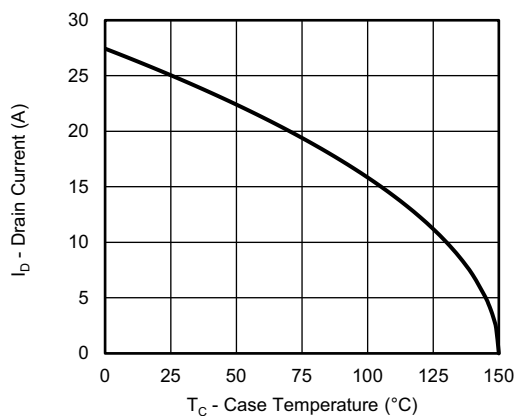
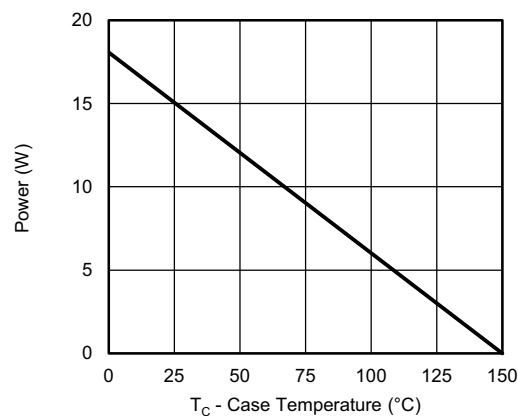
Notes

- a. Guaranteed by design, not subject to production testing
b. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$

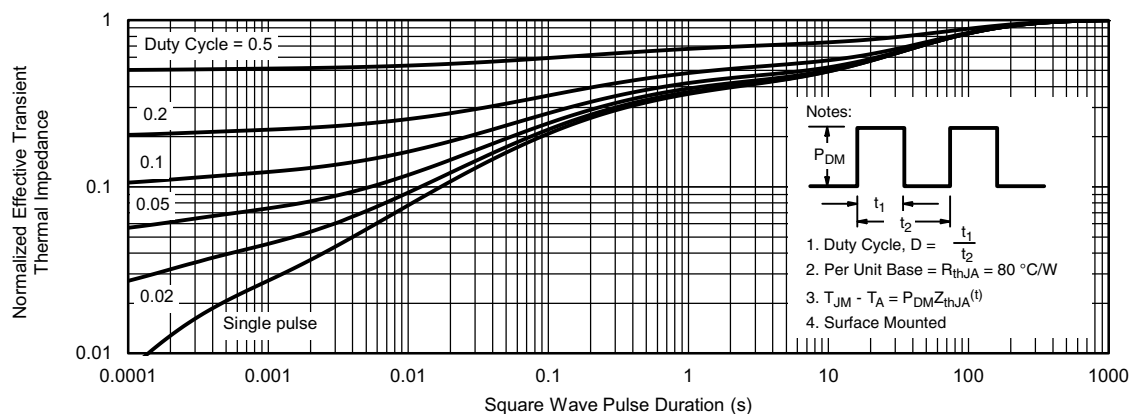
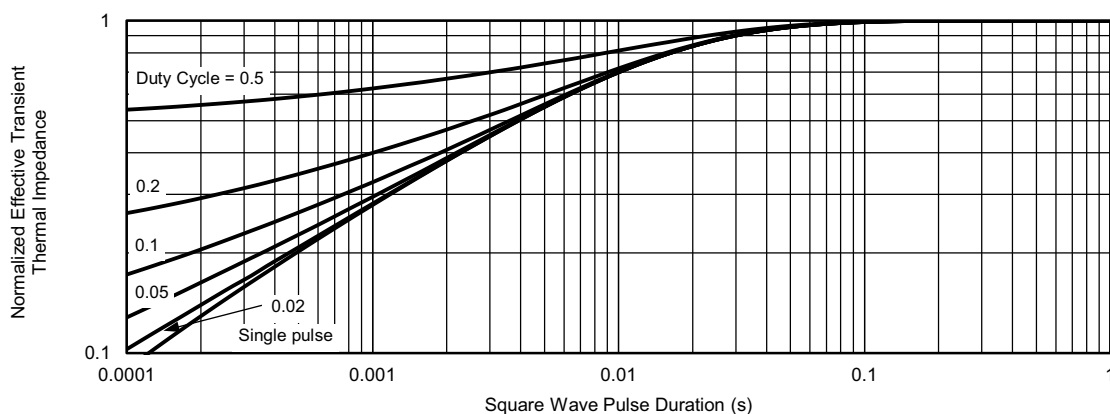
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

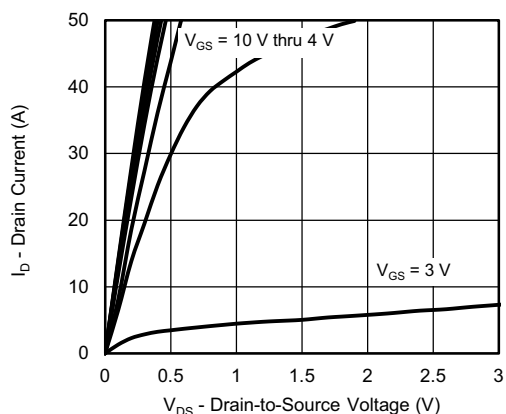
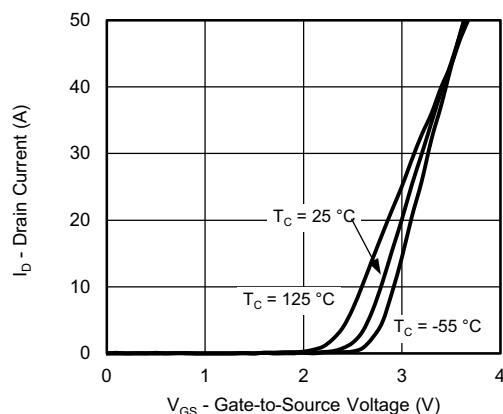
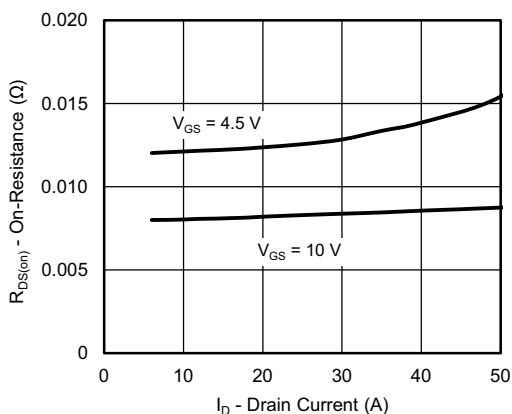
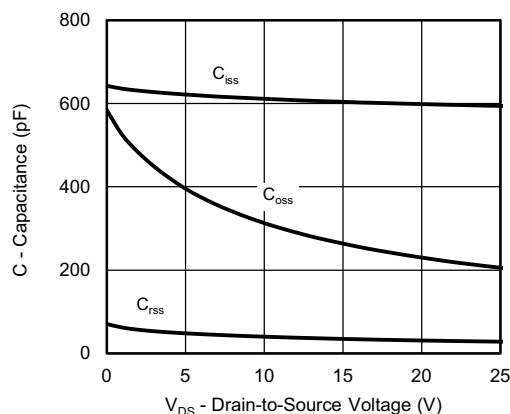
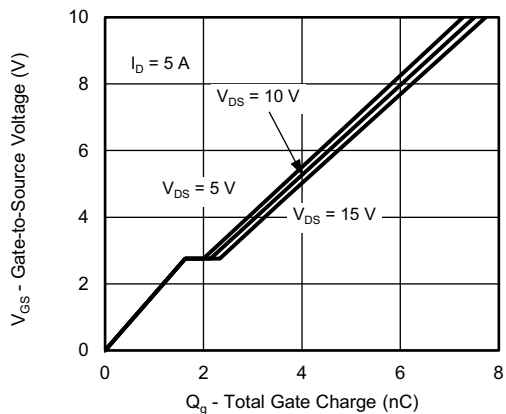
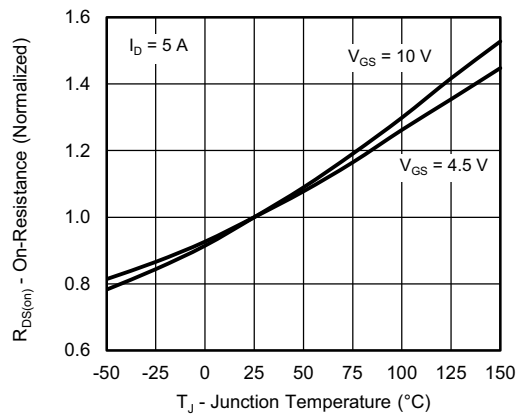
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature

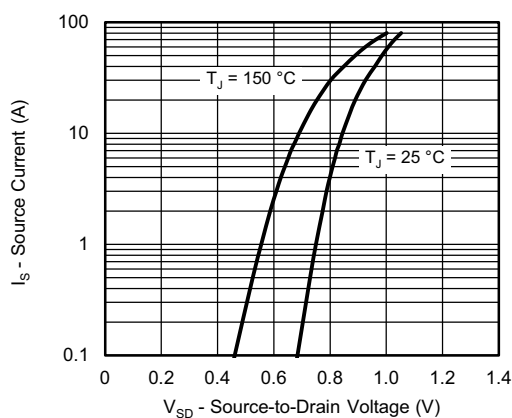
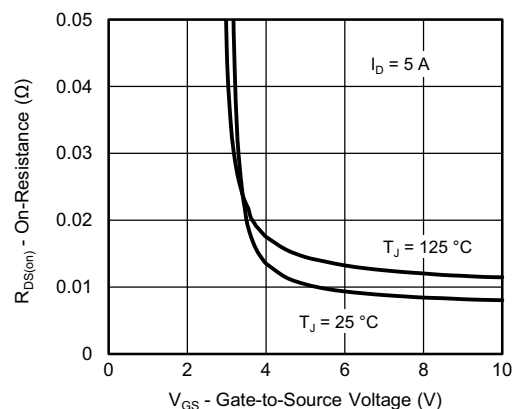
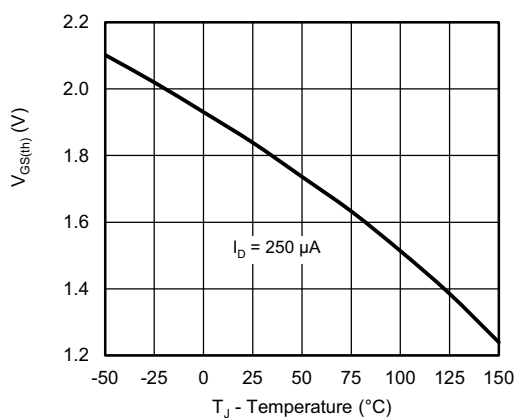
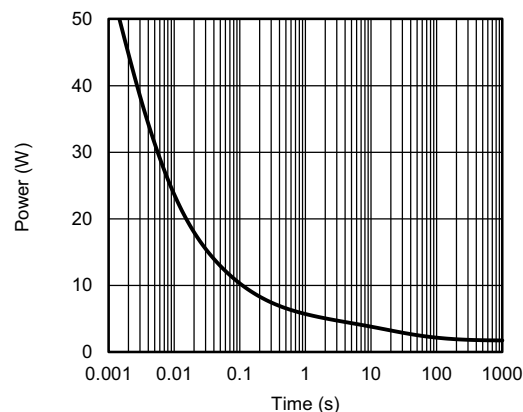
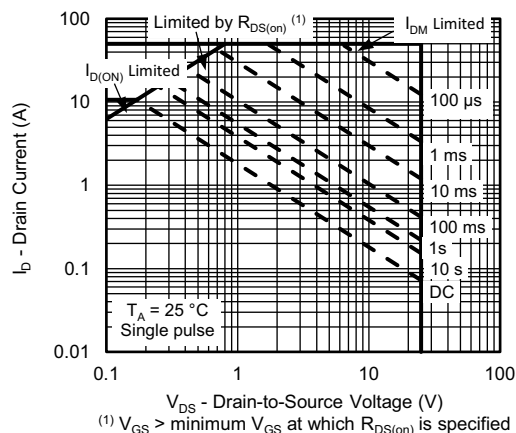
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Single Pulse Power, Junction-to-Ambient

Safe Operating Area, Junction-to-Ambient

CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Current Derating ^a

Power, Junction-to-Case
Note

- a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

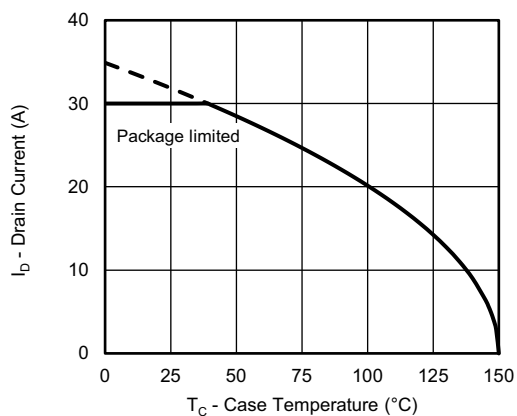
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Case

CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature

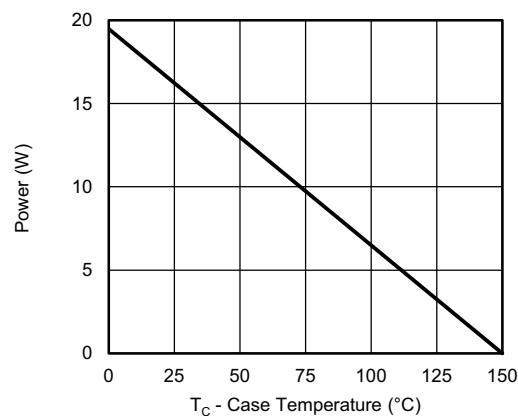
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Single Pulse Power, Junction-to-Ambient

Safe Operating Area, Junction-to-Ambient



CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



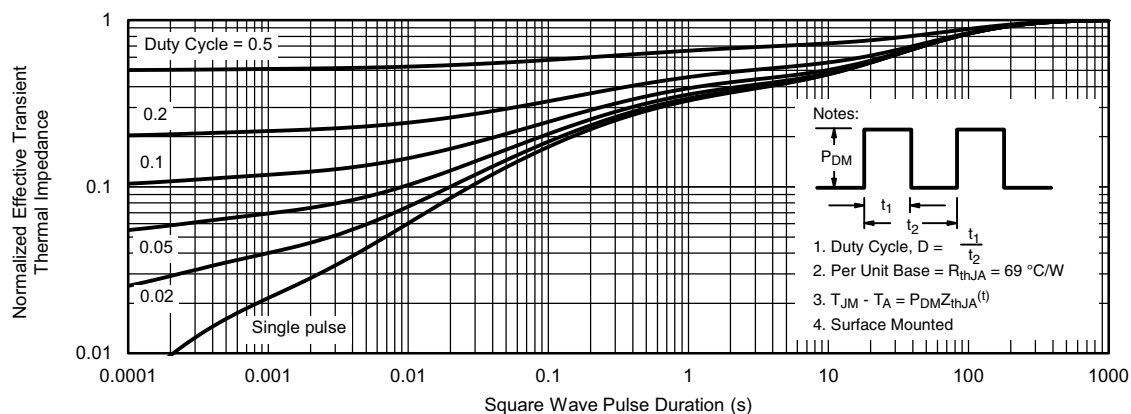
Power, Junction-to-Case

Note

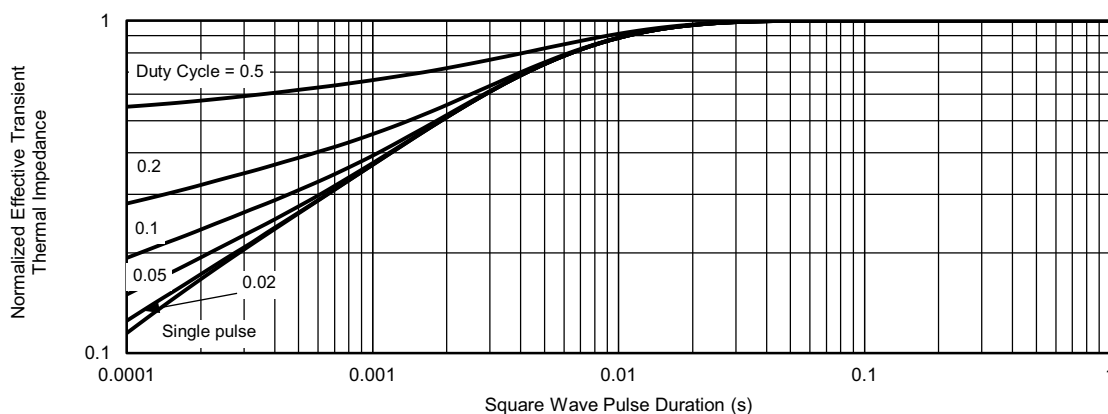
- a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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**Стандарт
Электрон
Связь**

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Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

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